

# **MSC180SMA120S**

## Silicon Carbide N-Channel Power MOSFET

#### **Product Overview**

The silicon carbide (SiC) power MOSFET product line from Microsemi increases the performance over silicon MOSFET and silicon IGBT solutions while lowering the total cost of ownership for high-voltage applications. The MSC180SMA120S device is a 1200 V, 180 m $\Omega$  SiC MOSFET in a TO-268 (D3PAK) package.



1—Gate 2—Drain 3—Source Backside—Drain



#### **Features**

The following are key features of the MSC180SMA120S device:

- · Low capacitances and low gate charge
- · Fast switching speed due to low internal gate resistance (ESR)
- Stable operation at high junction temperature, T<sub>J(max)</sub> = 175 °C
- · Fast and reliable body diode
- · Superior avalanche ruggedness
- RoHS compliant

#### **Benefits**

The following are benefits of the MSC180SMA120S device:

- · High efficiency to enable lighter, more compact system
- · Simple to drive and easy to parallel
- Improved thermal capabilities and lower switching losses
- · Eliminates the need for external freewheeling diode
- Lower system cost of ownership

#### **Applications**

The MSC180SMA120S device is designed for the following applications:

- · PV inverter, converter, and industrial motor drives
- · Smart grid transmission and distribution
- Induction heating and welding
- H/EV powertrain and EV charger
- Power supply and distribution

## 1. Device Specifications

This section shows the specifications of the MSC180SMA120S device..

### 1.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings of the MSC180SMA120S device.

Table 1-1. Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
V <sub>DSS</sub>	Drain source voltage	1200	V
I <sub>D</sub>	Continuous drain current at T <sub>C</sub> = 25 °C	ontinuous drain current at T <sub>C</sub> = 25 °C 21	
	Continuous drain current at T <sub>C</sub> = 100 °C	15	
I <sub>DM</sub>	Pulsed drain current <sup>1</sup>	40	
V <sub>GS</sub>	Gate-source voltage	23 to -10	V
P <sub>D</sub>	Total power dissipation at T <sub>C</sub> = 25 °C	125	W
	Linear derating factor	0.85	W/°C

#### Note:

1. Repetitive rating: pulse width and case temperature limited by maximum junction temperature.

The following table shows the thermal and mechanical characteristics of the MSC180SMA120S device.

**Table 1-2. Thermal and Mechanical Characteristics** 

Symbol	Characteristic/Test Conditions	Min	Тур	Max	Unit
$R_{\theta JC}$	Junction-to-case thermal resistance		0.79	1.18	°C/W
T <sub>J</sub>	Operating junction temperature	<b>-</b> 55		175	°C
T <sub>STG</sub>	Storage temperature	<b>-</b> 55		150	°C
T <sub>L</sub>	Soldering temperature for 10 seconds (1.6 mm from case)			300	°C
Wt	Package weight		0.14		oz
			4.0		g

#### 1.2 Electrical Performance

The following table shows the static characteristics of the MSC180SMA120S device.  $T_J$  = 25 °C unless otherwise specified.

Table 1-3. Static Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$	1200			V
R <sub>DS(on)</sub>	Drain-source on resistance <sup>1</sup>	$V_{GS} = 20 \text{ V}, I_D = 8 \text{ A}$		180	225	mΩ
V <sub>GS(th)</sub>	Gate-source threshold voltage	$V_{GS} = V_{DS}$ , $I_D = 500 \mu A$	1.9	3.26		V

continued						
Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
$\Delta V_{GS(th)}/$ $\Delta T_J$	Threshold voltage coefficient	$V_{GS} = V_{DS}$ , $I_D = 500 \mu A$		-5.8		mV/°C
I <sub>DSS</sub>	Zero gate voltage drain current	V <sub>DS</sub> = 1200 V, V <sub>GS</sub> = 0 V			100	μA
		$V_{DS}$ = 1200 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			500	
I <sub>GSS</sub>	Gate-source leakage current	V <sub>GS</sub> = 20 V/–10 V			±100	nA

#### Note:

1. Pulse test: pulse width < 380  $\mu$ s, duty cycle < 2%.

The following table shows the dynamic characteristics of the MSC180SMA120S device.  $T_J$  = 25 °C unless otherwise specified.

**Table 1-4. Dynamic Characteristics** 

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
C <sub>iss</sub>	Input capacitance	V <sub>GS</sub> = 0 V, V <sub>DD</sub> = 1000 V, V <sub>AC</sub> = 25		510		pF
C <sub>rss</sub>	Reverse transfer capacitance	mV, <i>f</i> = 1 MHz		4		
C <sub>oss</sub>	Output capacitance			45		
Qg	Total gate charge	$V_{GS} = -5 \text{ V/20 V}, V_{DD} = 800 \text{ V}, I_{D} =$		34		nC
$Q_{gs}$	Gate-source charge	40 A		10		
$Q_{gd}$	Gate-drain charge			9		
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 800 \text{ V}, V_{GS} = -5 \text{ V}/20 \text{ V}, I_{D} =$				ns
t <sub>r</sub>	Voltage rise time	10 A, $R_{g(ext)}$ = 8.0 $\Omega$ , Freewheeling diode = MSC180SMA120S ( $V_{GS}$ = $-5$ V)				
t <sub>d(off)</sub>	Turn-off delay time					
t <sub>f</sub>	Voltage fall time					
E <sub>on</sub>	Turn-on switching energy			210		μJ
E <sub>off</sub>	Turn-off switching energy			23		
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 800 \text{ V}, V_{GS} = -5 \text{ V}/20 \text{ V}, I_{D} =$				ns
t <sub>r</sub>	Voltage rise time	10 A, $R_{g(ext)}$ = 8.0 $\Omega$ , Freewheeling diode = MSC010SDA120B				
t <sub>d(off)</sub>	Turn-off delay time					
t <sub>f</sub>	Voltage fall time					
E <sub>on</sub>	Turn-on switching energy			170		μJ
E <sub>off</sub>	Turn-off switching energy			23		
ESR	Equivalent series resistance	f = 1 MHz, 25 mV, drain short		3.29		Ω
SCWT	Short circuit withstand time	V <sub>DS</sub> = 960 V, V <sub>GS</sub> = 20 V				μs
E <sub>AS</sub>	Avalanche energy, single pulse	V <sub>DS</sub> = 150 V, I <sub>D</sub> = 30 A				mJ

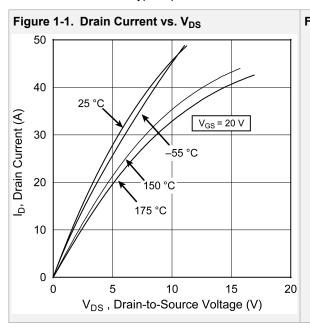
The following table shows the body diode characteristics of the MSC180SMA120S device.  $T_J$  = 25 °C unless otherwise specified.

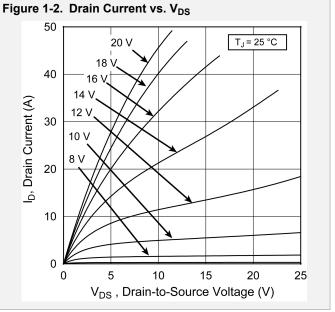
Table 1-5. Body Diode Characteristics

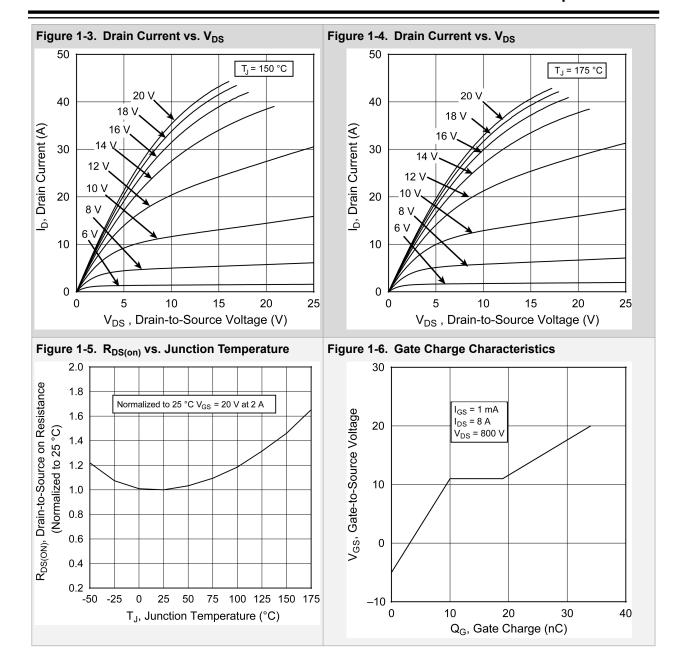
Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
V <sub>SD</sub>	Diode forward voltage	I <sub>SD</sub> = 0 V, V <sub>GS</sub> = 0 V		3.81		V
		I <sub>SD</sub> = 0 V, V <sub>GS</sub> = -5 V		3.96		
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 10 \text{ A}, V_{GS} = -5 \text{ V}, V_{DD} =$		28		ns
Q <sub>rr</sub>	Reverse recovery charge	800 V, dl/dt = $-1120$ A/ $\mu$ s, Drive Rg = 8 $\Omega$		88		nC
I <sub>RRM</sub>	Reverse recovery current			4.2		Α

### 1.3 Typical Performance Curves

This section shows the typical performance curves of the MSC180SMA120S device.







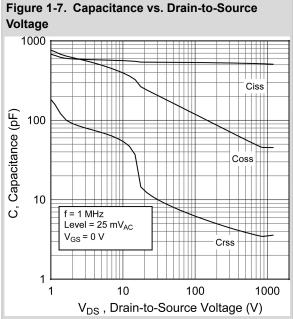


Figure 1-8.  $I_D$  vs.  $V_{DS}$   $3^{rd}$  Quadrant Conduction

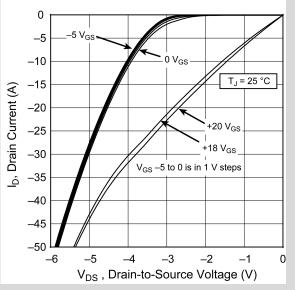


Figure 1-9.  $I_D$  vs.  $V_{DS}$  3<sup>rd</sup> Quadrant Conduction

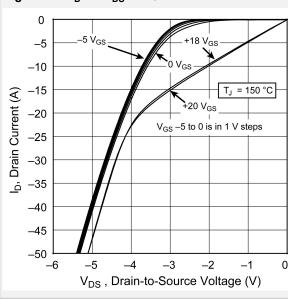
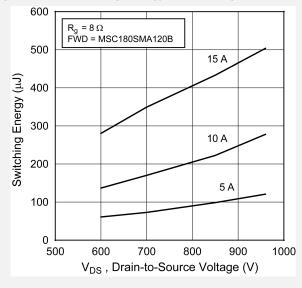


Figure 1-10. Switching Energy Eon vs.  $V_{DS} \& I_{D}$ 



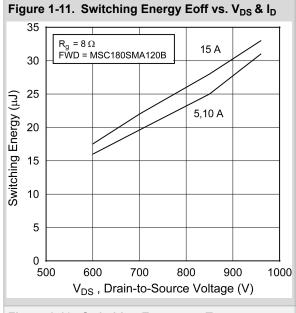
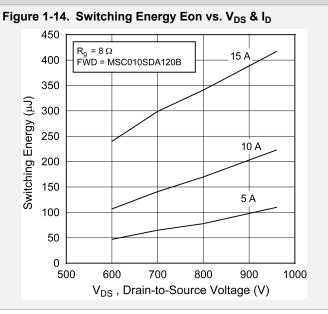
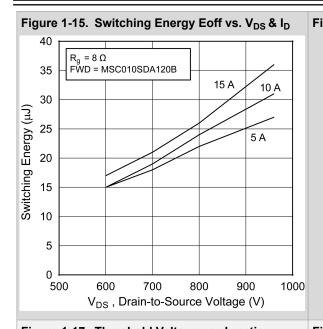


Figure 1-12. Switching Energy vs. Rq V<sub>DS</sub> = 800 V I<sub>D</sub> = 10 A FWD = MSC180SMA120B  $E_{tot}$ 300 Switching Energy (μJ)  $\mathsf{E}_{\mathsf{on}}$ 200 100  $\mathsf{E}_{\mathsf{off}}$ 0 0 2 4 6 8 10 12 14 16 18 R<sub>g</sub> (Ohms)

Figure 1-13. Switching Energy vs. Temperature 400  $V_{DS} = 800 V$  $E_{tot}$ I<sub>D</sub> = 10 A 350  $R_g = 8 \Omega$ FWD = MSC180SMA120B 300 Switching Energy (µJ)  $\mathsf{E}_{\mathsf{on}}$ 250 200 150 100  $\mathsf{E}_{\mathsf{off}}$ 50 75 100 150 0 25 50 125 Junction Temperature (°C)





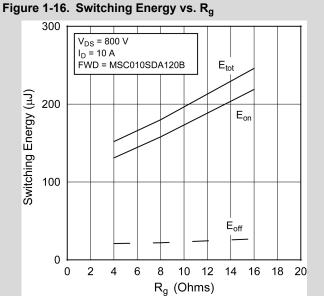
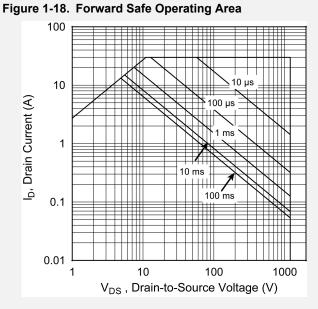
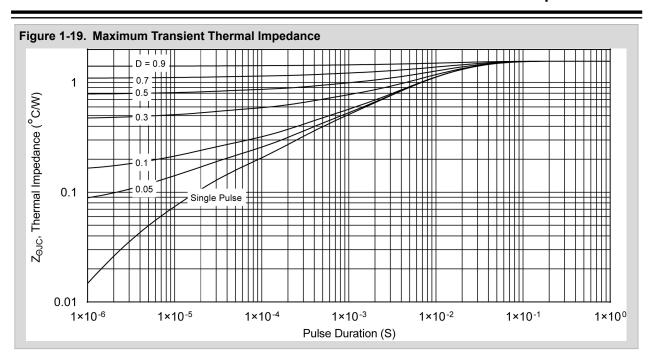


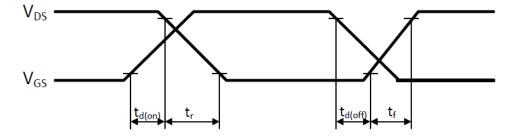
Figure 1-17. Threshold Voltage vs. Junction Temp. 4.5 4.0  $V_{GS} = V_{DS}$ ,  $I_D = 100 \ \mu A$ V<sub>GS(th)</sub> Threshold Voltage (V) 3.5 3.0 2.5 2.0 1.5 1.0 0.5 50 75 100 125 150 175 -50 -25 25 T<sub>J</sub>, Junction Temperature (°C)





The following figure shows the switching waveform diagram of the MSC180SMA120S device.

Figure 1-20. Switching Waveform



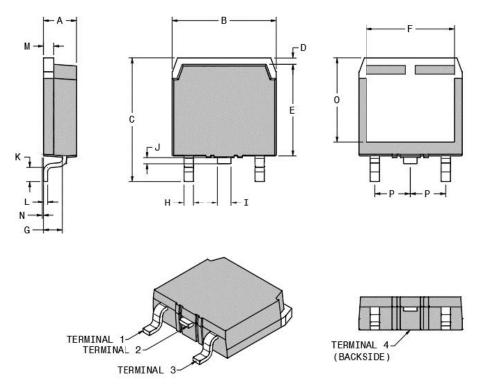
## 2. Package Specification

This section shows the package specification of the MSC180SMA120S device.

### 2.1 Package Outline Drawing

The following figure illustrates the TO-268 package outline of the MSC180SMA120S device.

Figure 2-1. Package Outline Drawing



The following table shows the TO-268 dimensions and should be used in conjunction with the package outline drawing.

Table 2-1. TO-268 Dimensions

Symbol	Min (mm)	Max (mm)	Min (in.)	Max (in.)
Α	4.90	5.10	0.193	0.201
В	15.85	16.20	0.624	0.638
С	18.70	19.10	0.736	0.752
D	1.00	1.025	0.039	0.049
E	13.80	14.00	0.543	0.551
F	13.30	13.60	0.524	0.535
G	2.70	2.90	0.106	0.114
Н	1.15	1.45	0.045	0.057
1	1.95	2.21	0.077	0.087

# **MSC180SMA120S**

# **Package Specification**

continued						
Symbol	Min (mm)	Max (mm)	Min (in.)	Max (in.)		
J	0.94	1.40	0.037	0.055		
K	2.40	2.70	0.094	0.106		
L	0.40	0.60	0.016	0.024		
M	1.45	1.60	0.057	0.063		
N	0.00	0.018	0.00	0.007		
0	12.40	12.70	0.488	0.500		
Р	5.45 BSC (nom.)		0.215 BSC (nom.)			
Terminal 1	Gate					
Terminal 2	Drain					
Terminal 3	Source					
Terminal 4	Drain					

# 3. Revision History

Table 3-1. Revision History

Revision	Date	Description
A	03/2021	Document created.

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